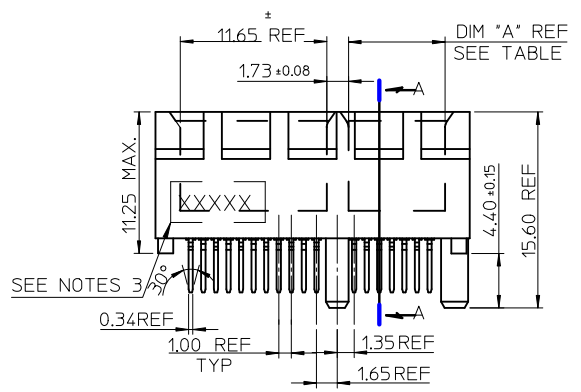
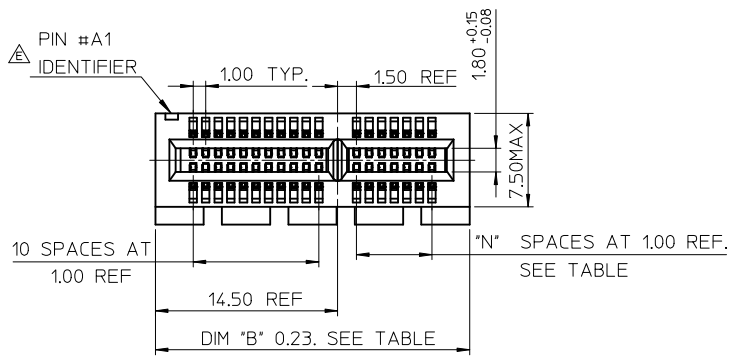
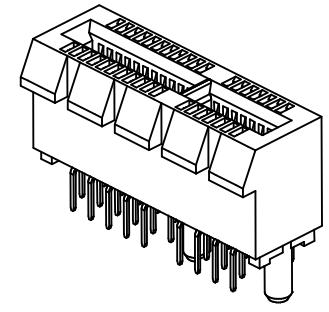
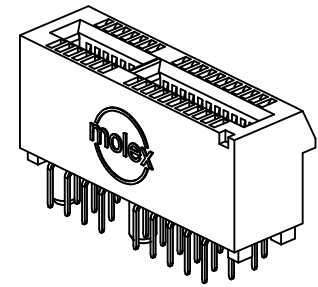
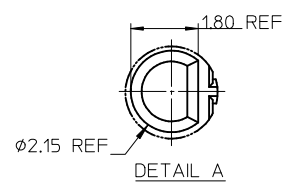


SECTION A-A



NOTES:

1.MATERIALS:

1-1.HOUSING: SEE TABLE ,GLASS FIBER FILLED UL94V-0, COLOR: SEE TABLE.

1-2.CONTACT: SEE TABLE

2.PLATING:

2-1.CONTACT AREA: GOLD, THICKNESS : SEE TABLE .

2-2.SOLDER TAIL: 100 MICRINCH MIN. TIN PLATING.

2-3.UNDER PLATING: NICKEL PLATING OVERALL.

3.WEEK CODE: XX(YEAR) XX(WEEK) X(LOCATION).

4.PRODUCT SPECIFICATION REFER TO PS-87715-200.

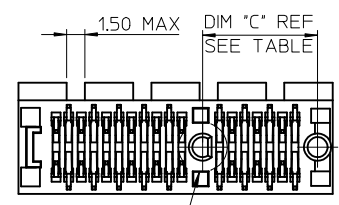
5.PACKAGING SPECIFICATION REFER TO PK-87715-207.

6.TEST SUMMARY:REFER TO TS-87715-207.

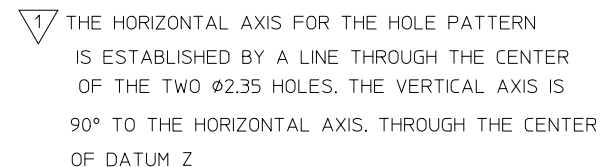
7.LEAD FREE AND ROHS COMPLIANCE PRODUCT.

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'A' REF	DIM 'B' REF	DIM 'C' REF
X1	36	6	7.65	25.00	9.15
X4	64	20	21.65	39.00	23.15
X8	98	37	38.65	56.00	40.15
X16	164	70	71.65	89.00	73.15

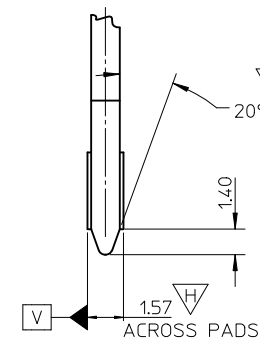
PCB THK (REF)	DIM 'D'
1.60	2.30
1.58	2.54
2.36	3.00



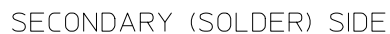
REVISED EC NO: SH2010-0468 DRAWNR:ZHANG CHKD:ALLEN LIN APPR:X.J.SONG H	DESCRIPTION REV	QUALITY SYMBOLS F_A=0 F_B=0 F_P=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	TITLE PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION) MOLEX INCORPORATED
				mm	INCH	DRAWN BY TOM	DATE 2004/07/20	DOCUMENT NO. SD-87715-207	SHEET NO. 1 OF 4		
			4 PLACES	± ---	± ---	CHECKED BY ALLEN LIN	DATE 2004/07/20				
			3 PLACES	± ---	± ---	APPROVED BY WILSON	DATE 2004/07/20				
			2 PLACES	± 0.25	± ---	MATERIAL NO.					
			1 PLACE	± 0.25	± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS					
			ANGULAR ± 3 °			SEE SHEET 4		SD-87715-207			
						SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



SEE SHEET 1 EC NO: SH2010-0468 DRAWN BY: 2010/06/15 CHK'D: 2010/07/20 ALLEN LIN APPR: XJSUNG 2010/07/20	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY	DATE	TITLE PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION)  MOLEX INCORPORATED		
			4 PLACES	± ---	± ---	TOM	2004/07/20			
			3 PLACES	± ---	± ---	CHECKED BY	DATE			
			2 PLACES	± 0.25	± ---	ALLEN LIN	2004/07/20			
			1 PLACE	± 0.25	± ---	APPROVED BY	DATE	MATERIAL NO. SEE SHEET 4	DOCUMENT NO. SD-87715-207	SHEET NO. 2 OF 4
			ANGULAR ± 3 °		WILSON	2004/07/20				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



PRIMARY (COMPONENT) SIDE



3. TOLERANCE: .XX±.13

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'B'	'C' 
X1	36	6	8.15	B17
X4	64	20	22.15	B17, B31
X8	98	37	39.15	B17, B31 B48
X16	164	70	72.15	B17, B31 B48, B81

tb_frame_A3_P_AM_T
Rev. F 2009/06/18

F

F

E

E

D

D

C

C

B

B

A

A

H	MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
	87715-9001	36	NYLON46	BLACK	PHOSPHOR BRONZE	10 MICROINCH	2.54
	87715-9003					GOLD FLASH	3.00
	87715-9004					10 MICROINCH	
	87715-9007					GOLD FLASH	2.30
	87715-9008					15 MICROINCH	

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9100	64	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54
87715-9101					10 MICROINCH	
87715-9102					15 MICROINCH	3.00
87715-9103					GOLD FLASH	
87715-9104					10 MICROINCH	2.54
87715-9105					15 MICROINCH	
87715-9106					30 MICROINCH	2.30
87715-9107					GOLD FLASH	3.00
87715-9108					15 MICROINCH	
87715-9109					30 MICROINCH	

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9200	98	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54
87715-9201					10 MICROINCH	
87715-9202					15 MICROINCH	3.00
87715-9203					GOLD FLASH	
87715-9204					10 MICROINCH	2.54
87715-9205					15 MICROINCH	
87715-9206					30 MICROINCH	2.30
87715-9207					GOLD FLASH	3.00
87715-9208					15 MICROINCH	
87715-9209					30 MICROINCH	

MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
87715-9602	98	NYLON46	BLACK	BRASS	15 MICROINCH	2.54

H	MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH
	87715-9301	164	NYLON46	BLACK	PHOSPHOR BRONZE	10 MICROINCH	2.54
	87715-9304						3.00
	87715-9307					GOLD FLASH	2.30
	87715-9308					15 MICROINCH	

SEE SHEET 1

EC NO: SH2010-0468

DRWNR:ZHANG

CHKD:ALLEN LIN

APPR:XJ.SONG

REV

2010/06/15

2004/07/20

2010/07/02

QUALITY SYMBOLS

F_A=0

F_C=0

F_P=0

DESCRIPTION

GENERAL TOLERANCES (UNLESS SPECIFIED)

mm

INCH

4 PLACES

3 PLACES

2 PLACES

1 PLACE

± ---

± ---

± 0.25

± 0.25

± ---

± ---

± ---

± ---

ANGULAR ± 3 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE

MM ONLY

DRAWN BY

DATE

CHECKED BY

DATE

APPROVED BY

DATE

MATERIAL NO.

SEE TABLE

SIZE

A3

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

SCALE

DESIGN UNITS

METRIC

THIRD ANGLE PROJECTION

PCI EXPRESS

EDGE CARD CONNECTOR

(LEAD FREE VERSION)

molex

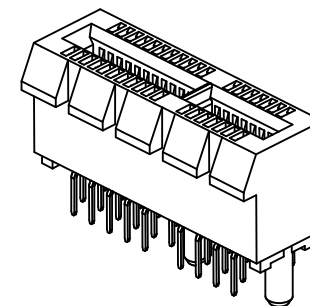
MOLEX INCORPORATED

DOCUMENT NO.

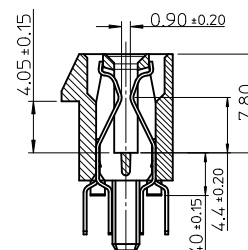
SD-87715-207

SHEET NO.

4 OF 4



5.TEST SUMMARY:REFER TO TS-87715-207.

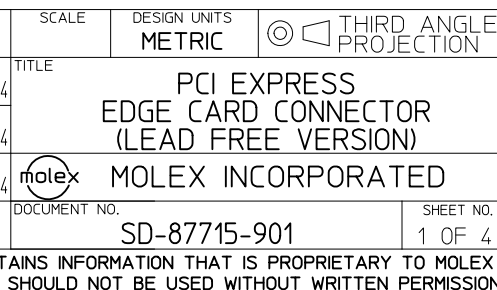


1.80 REF

Ø2.15 REF

DETAIL A

PCB THK (REF)	DIM "D"
1.58	2.54
2.36	3.00



10 9 8 7 6 5 4 3 2 1

F

E

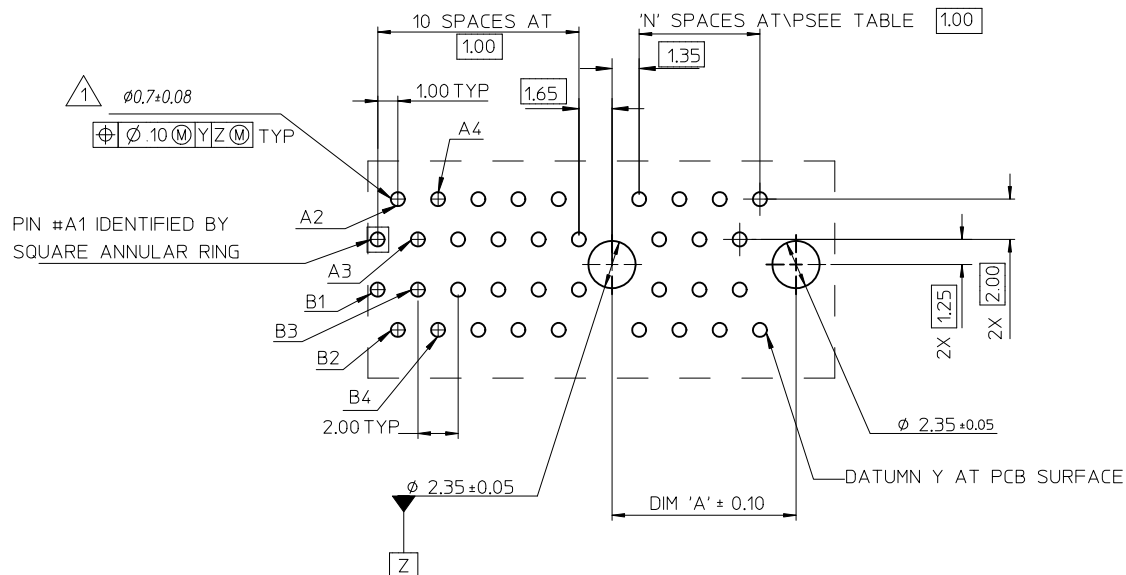
D

C

B

A

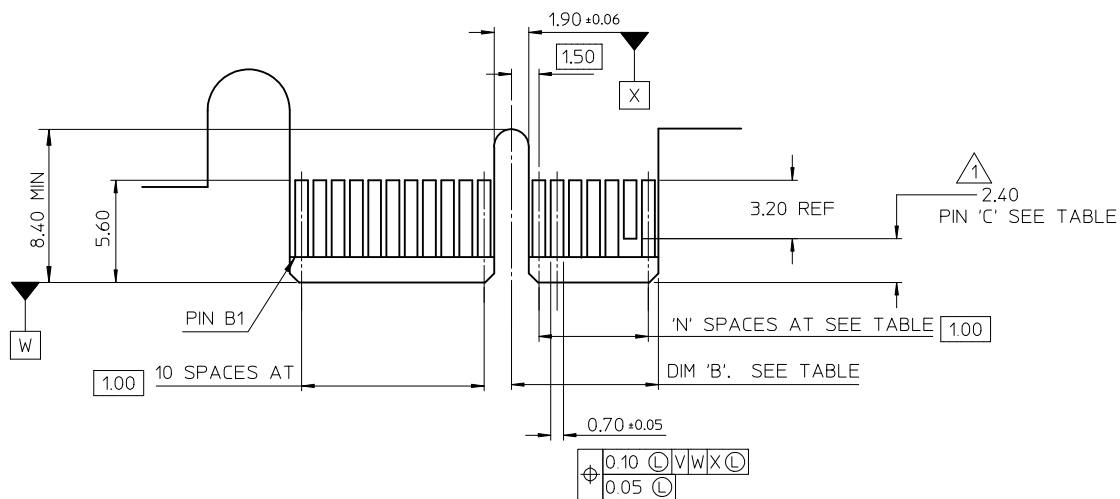
△1 THE HORIZONTAL AXIS FOR THE HOLE PATTERN IS ESTABLISHED BY A LINE THROUGH THE CENTER OF THE TWO $\phi 2.35$ HOLES. THE VERTICAL AXIS IS 90° TO THE HORIZONTAL AXIS, THROUGH THE CENTER OF DATUM Z



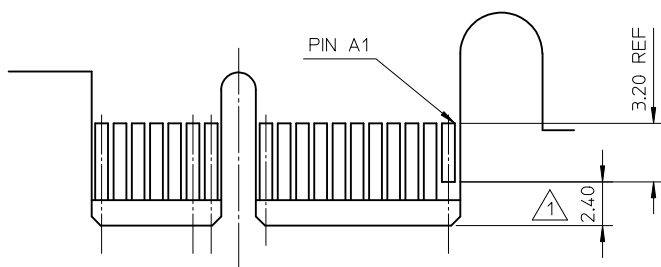
CONNECTOR LINK WIDTH	# POS REF	N	DIM 'A'
X1	36	6	9.15
X16	164	70	73.15

SEE SHEET 1 EC NO: SH2011-0358 DRWN: FYANG05 CHKD: APPR: RZHANG REV	QUALITY SYMBOLS FA=0 FG=0 FP=0	DESCRIPTION 2011/06/02 2011/06/07	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION		
				mm	INCH	DRAWN BY DAVID HU	DATE 2007/05/14	PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION)			
			4 PLACES	± ---	± ---	CHECKED BY HARVEY	DATE 2007/05/14				
			3 PLACES	± ---	± ---	APPROVED BY JENNY CHEN	DATE 2007/05/14	MOLEX INCORPORATED			
			2 PLACES	± 0.25	± ---	MATERIAL NO. SEE SHEET 1					
			1 PLACE	± 0.25	± ---	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					
			ANGULAR ± 3 °								
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS								

9 8 7 6 5 4 3 2 1



PRIMARY (COMPONENT) SIDE



SECONDARY (SOLDER) SIDE

- 1 NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR PINS A1 AND "C".
- 2 CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.
- 3 TOLERANCE: .XX±.13

CONNECTOR LINK WIDTH	# POS REF	N	DIM 'B'	'C' 1
X1	36	6	8.15	B17
X16	164	70	72.15	B17, B31 B48,B81

SEE SHEET 1 EC NO: SH2011-0358 DRAWN: FANG05 CHK'D: CHYD APPR: RZHANG 2011/06/02 2011/06/07	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)				DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
							MM ONLY			METRIC			
					mm	INCH	DRAWN BY	DATE	PCI EXPRESS EDGE CARD CONNECTOR (LEAD FREE VERSION)				
			4 PLACES		± ---	± ---	DAVID HU	2007/05/14					
			3 PLACES		± ---	± ---	CHECKED BY	DATE	MOLEX INCORPORATED				
			2 PLACES		± 0.25	± ---	HARVEY	2007/05/14					
			1 PLACE		± 0.25	± ---	APPROVED BY	DATE	SD-87715-901				
					ANGULAR ± 3 °		JENNY CHEN	2007/05/14					
							MATERIAL NO.		SHEET NO. 3 OF 4				
REV			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SEE SHEET 1		SD-87715-901				
							SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH	PEG 1	PEG 2	DESCRIPTION
87715-9000	36	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54	WITH	WITH	TOOLED
87715-9002					15 MICROINCH				
87715-9005					15 MICROINCH	3.00			
87715-9006					30 MICROINCH	2.54			
87715-9009					30 MICROINCH	3.00			



MOLEX P/N	CIRCUIT SIZE	HOUSING MATERIAL	HOUSING COLOR	TERMINAL MATERIAL	CONTACT PLATING	SOLDER TAIL 'D' LENGTH	PEG 1	PEG 2	DESCRIPTION
87715-9300	164	NYLON46	BLACK	PHOSPHOR BRONZE	GOLD FLASH	2.54	WITH	WITH	TOOLED
87715-9302					15 MICROINCH				
87715-9303					GOLD FLASH	3.00			
87715-9305					15 MICROINCH				
87715-9306					30 MICROINCH	2.54			
87715-9309					30 MICROINCH	3.00			

SEE SHEET 1

EC NO: SH2011-0358

DRWN:FYANG05

CH'KD:

APPR:RZHANG

2011/06/02

2011/06/07

QUALITY SYMBOLS

$F_A=0$

$F_C=0$

$F_P=0$

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	$\pm$ ---	$\pm$ ---
3 PLACES	$\pm$ ---	$\pm$ ---
2 PLACES	$\pm$ 0.25	$\pm$ ---
1 PLACE	$\pm$ 0.25	$\pm$ ---

ANGULAR $\pm$ 3 °

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE

MM ONLY

DRAWN BY	DATE
DAVID HU	2007/05/14
CHECKED BY	DATE
HARVEY	2007/05/14
APPROVED BY	DATE
JENNY CHEN	2007/05/14

MATERIAL NO.

SEE SHEET 1

SIZE
A3

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

SCALE

DESIGN UNITS

METRIC

THIRD ANGLE PROJECTION

TITLE

PCI EXPRESS
EDGE CARD CONNECTOR
(LEAD FREE VERSION)

MOLEX INCORPORATED

DOCUMENT NO.

SD-87715-901

SHEET NO.

4 OF 4

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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moschip.ru_9